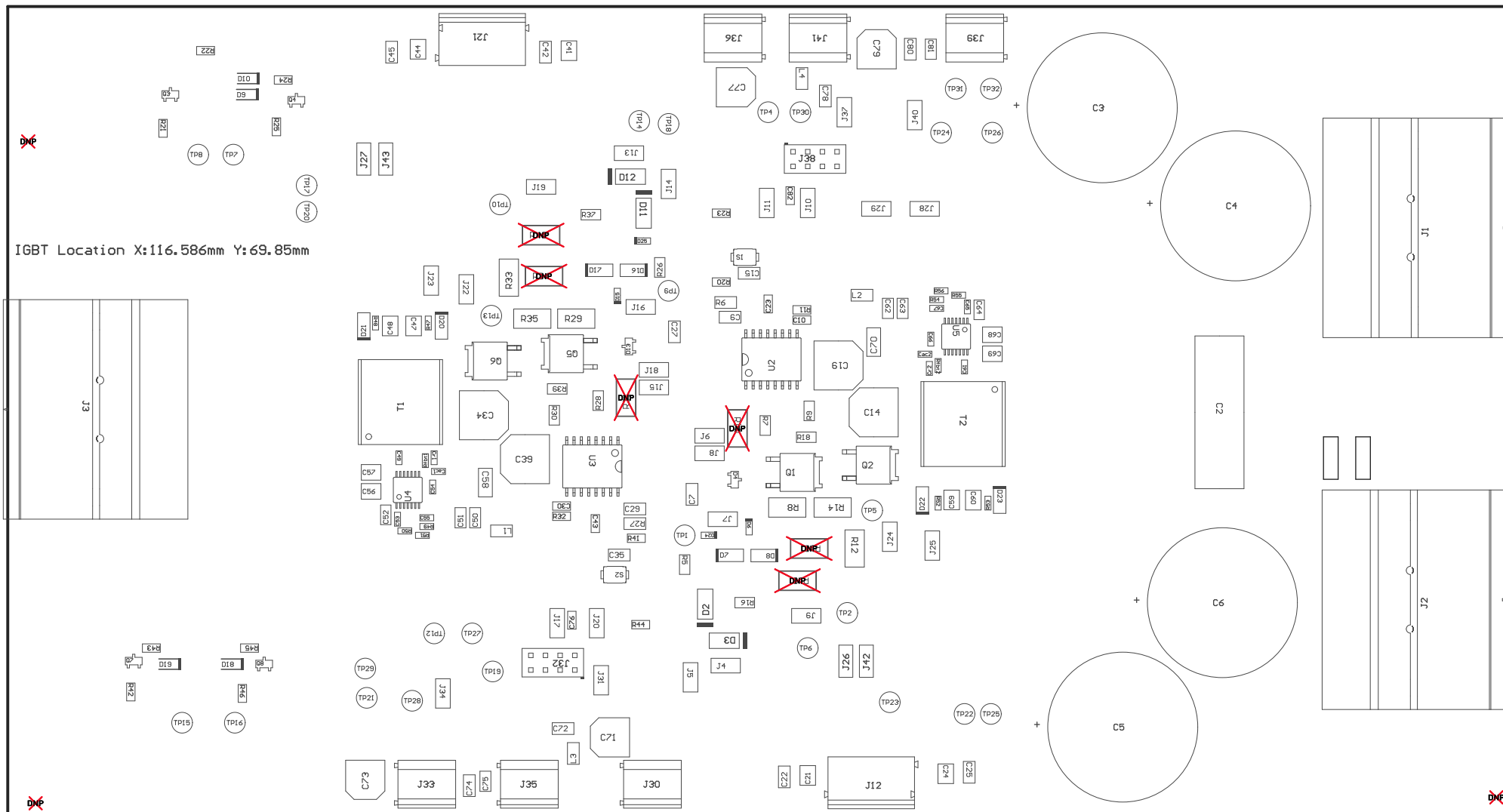


Z21 ■ This Assembly Note will show in the PcbDoc and associated outputs
 Z22 ■ This Assembly Note will show in the PcbDoc and associated outputs
 Z23 ■ This Assembly Note will show in the PcbDoc and associated outputs



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00794	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-00794		
PLOT NAME = Top Assembly Drawing	GENERATED : 3/23/2016 4:42:58 PM	TEXAS INSTRUMENTS	

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